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FFATURES

### SN74GTL16616 17-BIT LVTTL-TO-GTL/GTL+ UNIVERSAL BUS TRANSCEIVER WITH BUFFERED CLOCK OUTPUTS

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| ГС | AIURES   | DGG OR DL PACKAGE                      |                          |  |  |  |  |  |
|----|--|--|--------------------------|--|--|--|--|--|
| •  | Member of the Texas Instruments Widebus™             |  | P VIEW)                  |  |  |  |  |  |
|    | Family   | `````````````````````````````````````` |                          |  |  |  |  |  |
| •  | UBT <sup>™</sup> Transceiver Combines D-Type Latches |  | 56 CEAB                  |  |  |  |  |  |
|    | and D-Type Flip-Flops for Operation in               | LEAB 🛛 2                               | 55 CLKAB                 |  |  |  |  |  |
|    | Transparent, Latched, Clocked, or                    | A1 🛛 3                                 | 54 B1                    |  |  |  |  |  |
|    | Clock-Enabled Modes                                  | GND 4                                  | 53 GND                   |  |  |  |  |  |
| •  | OEC™ Circuitry Improves Signal Integrity and         | A2 🛛 5                                 | 52 B2                    |  |  |  |  |  |
|    | Reduces Electromagnetic Interference                 | A3 🛛 6                                 | 51 B3                    |  |  |  |  |  |
| •  | GTL Buffered CLKAB Signal (CLKOUT)                   | V <sub>CC</sub> (3.3 V) []7            | 50 V <sub>CC</sub> (5 V) |  |  |  |  |  |
| •  | Translates Between GTL/GTL+ Signal Levels            | A4 8                                   | 49 B4                    |  |  |  |  |  |
| •  | and LVTTL Logic Levels                               | A5 9                                   | 48 B5                    |  |  |  |  |  |
| •  | Supports Mixed-Mode (3.3 V and 5 V) Signal           | A6 [ 10<br>GND [ 11                    | 47 B6                    |  |  |  |  |  |
| •  | Operation on A-Port and Control Inputs               |  | 46 GND<br>45 B7          |  |  |  |  |  |
| _  | • •  | A7 L 12<br>A8 L 13                     | 45 B7<br>44 B8           |  |  |  |  |  |
| •  | Equivalent to '16601 Function                        | A0 [ 13<br>A9 [ 14                     | 43 B9                    |  |  |  |  |  |
| •  | I <sub>off</sub> Supports Partial-Power-Down Mode    | A10 15                                 | 43 B3<br>42 B10          |  |  |  |  |  |
|    | Operation  | A11 11                                 | E                        |  |  |  |  |  |
| •  | Bus Hold on Data Inputs Eliminates the Need          | A12 17                                 | E                        |  |  |  |  |  |
|    | for External Pullup/Pulldown Resistors on            | GND 18                                 | 39 GND                   |  |  |  |  |  |
|    | A Port   | A13 🛛 19                               | 38 B13                   |  |  |  |  |  |
| •  | Distributed V <sub>CC</sub> and GND Pins Minimize    | A14 🛛 20                               | 37 🛛 B14                 |  |  |  |  |  |
|    | High-Speed Switching Noise                           | A15 🛛 21                               | 36 B15                   |  |  |  |  |  |
| •  | Latch-Up Performance Exceeds 100 mA Per              | V <sub>CC</sub> (3.3 V) 🛛 22           | 35 🛛 V <sub>REF</sub>    |  |  |  |  |  |
|    | JESD 78, Class II                                    | A16 23                                 | 34 🛛 B16                 |  |  |  |  |  |
| •  | ESD Protection Exceeds JESD 22                       | A17 224                                | 33 🛛 B17                 |  |  |  |  |  |
|    | – 2000-V Human-Body Model (A114-A)                   | GND 25                                 | 32 GND                   |  |  |  |  |  |
|    |  |  | 31 CLKOUT                |  |  |  |  |  |
|    |  | OEBA                                   |                          |  |  |  |  |  |
|    |  | LEBA 28                                | 29 CEBA                  |  |  |  |  |  |
|    |  |  |                          |  |  |  |  |  |

### **DESCRIPTION/ORDERING INFORMATION**

The SN74GTL16616 is a 17-bit UBT™ transceiver that provides LVTTL-to-GTL/GTL+ and GTL/GTL+-to-LVTTL signal-level translation. Combined D-type flip-flops and D-type latches allow for transparent, latched, clocked, and clocked-enabled modes of data transfer identical to the '16601 function. Additionally, this device provides for a copy of CLKAB at GTL/GTL+ signal levels (CLKOUT) and conversion of a GTL/GTL+ clock to LVTTL logic levels (CLKIN). This device provides an interface between cards operating at LVTTL logic levels and a backplane operating at GTL/GTL+ signal levels. Higher-speed operation is a direct result of the reduced output swing (<1 V), reduced input threshold levels, and OEC<sup>™</sup> circuitry.

#### **ORDERING INFORMATION**

| T <sub>A</sub> | PACK        | AGE <sup>(1)</sup> | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-------------|--------------------|-----------------------|------------------|
|                | SSOP – DL   | Tube               | SN74GTL16616DL        | GTL16616         |
| –40°C to 85°C  | 550P - DL   | Tape and reel      | SN74GTL16616DLR       | GTL16616         |
|                | TSSOP – DGG | Tape and reel      | SN74GTL16616DGGR      | GTL16616         |

Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at (1) www.ti.com/sc/package.



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# **DESCRIPTION/ORDERING INFORMATION (CONTINUED)**

The user has the flexibility of using this device at either GTL ( $V_{TT} = 1.2$  V and  $V_{REF} = 0.8$  V) or the preferred higher noise margin GTL+ ( $V_{TT} = 1.5$  V and  $V_{REF} = 1$  V) signal levels. GTL+ is the Texas Instruments derivative of the Gunning Transceiver Logic (GTL) JEDEC standard JESD 8-3. The B port normally operates at GTL or GTL+ signal levels, while the A-port and control inputs are compatible with LVTTL logic levels and are 5-V tolerant.  $V_{REF}$  is the reference input voltage for the B port.  $V_{CC}$  (5 V) supplies the internal and GTL circuitry, while  $V_{CC}$  (3.3 V) supplies the LVTTL output buffers.

Data flow in each direction is controlled by output-enable (OEAB and OEBA), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. The clock can be controlled by the clock-enable (CEAB and CEBA) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if CEAB is low and CLKAB is held at a high or low logic level. If LEAB is low, the A-bus data is stored in the latch/flip-flop on the low-to-high transition of CLKAB if CEAB also is low. When OEAB is low, the outputs are active. When OEAB is high, the outputs are in the high-impedance state. Data flow for B to A is similar to that of A to B, but uses OEBA, LEBA, CLKBA, and CEBA.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

Active bus-hold circuitry holds unused or undriven LVTTL inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

|      |      | INPUTS |            |   | OUTPUT                        | MODE                       |
|------|------|--------|------------|---|-------------------------------|----------------------------|
| CEAB | OEAB | LEAB   | CLKAB      | Α | В                             | MODE                       |
| Х    | Н    | Х      | Х          | Х | Z                             | Isolation                  |
| L    | L    | L      | Н          | Х | B <sub>0</sub> <sup>(2)</sup> | Latabad stars as of A data |
| L    | L    | L      | L          | Х | B <sub>0</sub> <sup>(3)</sup> | Latched storage of A data  |
| Х    | L    | Н      | Х          | L | L                             | Transport                  |
| Х    | L    | Н      | Х          | Н | н                             | Transparent                |
| L    | L    | L      | $\uparrow$ | L | L                             |                            |
| L    | L    | L      | $\uparrow$ | Н | н                             | Clocked storage of A data  |
| Н    | L    | L      | Х          | Х | B <sub>0</sub> <sup>(3)</sup> | Clock inhibit              |

#### FUNCTION TABLE<sup>(1)</sup>

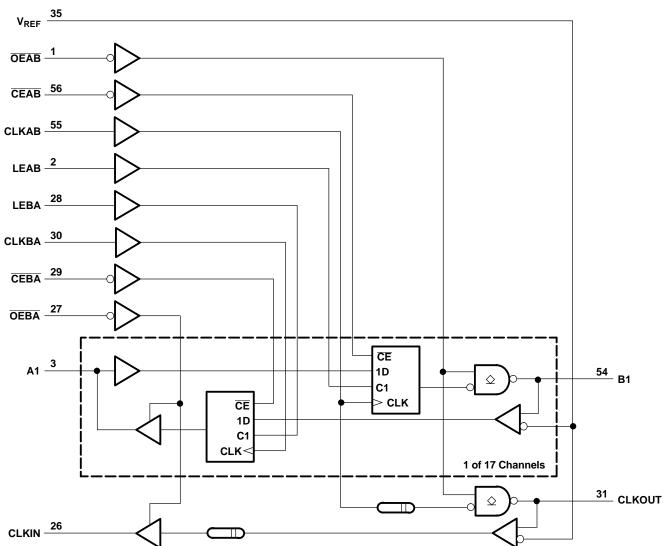
(1) A-to-B data flow is shown. B-to-A data flow is similar, but uses OEBA, LEBA, CLKBA, and CEBA. The condition when OEAB and OEBA are both low at the same time is not recommended.

 (2) Output level before the indicated steady-state input conditions were established, provided that CLKAB was high before LEAB went low

(3) Output level before the indicated steady-state input conditions were established



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# LOGIC DIAGRAM (POSITIVE LOGIC)

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#### Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                  |   | MIN                         | MAX  | UNIT |      |  |  |
|------------------|---|-----------------------------|------|------|------|--|--|
| V                | Supply voltage renge  | 3.3 V                       | -0.5 | 4.6  | V    |  |  |
| V <sub>CC</sub>  | Supply voltage range  | 5 V                         | -0.5 | 7    | v    |  |  |
| V                | Input voltage range <sup>(2)</sup>  | A-port and control inputs   | -0.5 | 7    | V    |  |  |
| VI               |   | B port and V <sub>REF</sub> | -0.5 | 4.6  | v    |  |  |
| V                | Voltage renge applied to any output in the high or never off state $(2)$          | A port                      | -0.5 | 7    | v    |  |  |
| Vo               | Voltage range applied to any output in the high or power-off state <sup>(2)</sup> | B port                      | -0.5 | 4.6  | v    |  |  |
|                  | Current into any output in the low state  | A port                      |      | 128  | mA   |  |  |
| I <sub>O</sub>   | Current into any output in the low state  | B port                      |      | 80   | mA   |  |  |
| I <sub>O</sub>   | Current into any A-port output in the high state <sup>(3)</sup>                   |                             |      | 64   | mA   |  |  |
|                  | Continuous current through each V <sub>CC</sub> or GND                            |                             |      | ±100 | mA   |  |  |
| I <sub>IK</sub>  | Input clamp current   | V <sub>1</sub> < 0          |      | -50  | mA   |  |  |
| I <sub>OK</sub>  | Output clamp current  | V <sub>O</sub> < 0          |      | -50  | mA   |  |  |
| 0                | Package thermal impedance <sup>(4)</sup>  | DGG package                 |      | 64   | °C/W |  |  |
| $\theta_{JA}$    | Fackage mermaninpedance.  | DL package                  | 56   |      | C/VV |  |  |
| T <sub>stg</sub> | Storage temperature range   |                             | -65  | 150  | °C   |  |  |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed. (2)

This current flows only when the output is in the high state and  $V_0 > V_{CC}$ . (3)

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

### Recommended Operating Conditions<sup>(1)(2)(3)(4)</sup>

|                  |                                |               | MIN                      | NOM | MAX                       | UNIT |  |
|------------------|--------------------------------|---------------|--------------------------|-----|---------------------------|------|--|
| M                | Current unalte ne              | 3.3 V         | 3.15                     | 3.3 | 3.45                      | V    |  |
| V <sub>CC</sub>  | Supply voltage                 | 5 V           | 4.75                     | 5   | 5.25                      | V    |  |
| M                | Torreinotion units as          | GTL           | 1.14                     | 1.2 | 1.26                      | V    |  |
| V <sub>TT</sub>  | Termination voltage            | GTL+          | 1.35                     | 1.5 | 1.65                      | v    |  |
| V                |                                | GTL           | 0.74                     | 0.8 | 0.87                      | V    |  |
| V <sub>REF</sub> | Reference voltage              | GTL+          | 0.87                     | 1   | 1.1                       | V    |  |
|                  |                                | B port        |                          |     | V <sub>TT</sub>           | V    |  |
| VI               | Input voltage                  | Except B port |                          |     | 5.5                       | V    |  |
| V                | Llich lovel input voltage      | B port        | V <sub>REF</sub> + 50 mV |     |                           | V    |  |
| V <sub>IH</sub>  | High-level input voltage       | Except B port | 2                        |     |                           |      |  |
| M                |                                | B port        |                          |     | $V_{REF} - 50 \text{ mV}$ | V    |  |
| V <sub>IL</sub>  | Low-level input voltage        | Except B port |                          |     | 0.8                       | v    |  |
| I <sub>IK</sub>  | Input clamp current            |               |                          |     | -18                       | mA   |  |
| I <sub>OH</sub>  | High-level output current      | A port        |                          |     | -32                       | mA   |  |
|                  |                                | A port        |                          |     | 64                        |      |  |
| I <sub>OL</sub>  | Low-level output current       | B port        |                          |     | 40                        | mA   |  |
| T <sub>A</sub>   | Operating free-air temperature |               | -40                      |     | 85                        | °C   |  |

(1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

Normal connection sequence is GND first,  $V_{CC} = 5$  V second, and  $V_{CC} = 3.3$  V, I/O, control inputs,  $V_{TT}$  and  $V_{REF}$  (any order) last.  $V_{TT}$  and  $R_{TT}$  can be adjusted to accommodate backplane impedances if the dc recommended I<sub>OL</sub> ratings are not exceeded.

(3)

(4)  $V_{\text{REF}}$  can be adjusted to optimize noise margins, but normally is two-thirds  $V_{\text{TT}}.$ 

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### **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

| PA                              | ARAMETER       |  | TEST CONDITIONS                 |                                       | MIN                   | TYP <sup>(1)</sup> | MAX  | UNIT |  |
|---------------------------------|----------------|--|---------------------------------|---------------------------------------|-----------------------|--------------------|------|------|--|
| V <sub>IK</sub>                 |                | V <sub>CC</sub> (3.3 V) = 3.15 V,                            | V <sub>CC</sub> (5 V) = 4.75 V, | I <sub>I</sub> = -18 mA               |                       |                    | -1.2 | V    |  |
|                                 |                | $V_{CC}$ (3.3 V) = 3.15 V to<br>$V_{CC}$ (5 V) = 4.75 V to 5 |                                 | I <sub>OH</sub> = -100 μA             | V <sub>CC</sub> - 0.2 |                    |      |      |  |
| V <sub>ОН</sub>                 | A port         |  |                                 | I <sub>OH</sub> = -8 mA               | 2.4                   |                    |      | V    |  |
|                                 |                | V <sub>CC</sub> (3.3 V) = 3.15 V,                            | $V_{CC} (5 V) = 4.75 V$         | I <sub>OH</sub> = -32 mA              | 2                     |                    |      |      |  |
|                                 |                |  |                                 | I <sub>OL</sub> = 100 μA              |                       |                    | 0.2  |      |  |
|                                 | Anort          | V (2.2.V) 2.45.V   |                                 | I <sub>OL</sub> = 16 mA               |                       |                    | 0.4  |      |  |
| V <sub>OL</sub>                 | A port         | $V_{CC}$ (3.3 V) = 3.15 V,                                   | $V_{CC}$ (5 V) = 4.75 V         | I <sub>OL</sub> = 32 mA               |                       |                    | 0.5  | V    |  |
|                                 |                |  |                                 | I <sub>OL</sub> = 64 mA               |                       |                    | 0.55 |      |  |
|                                 | B port         | V <sub>CC</sub> (3.3 V) = 3.15 V,                            | V <sub>CC</sub> (5 V) = 4.75 V, | I <sub>OL</sub> = 40 mA               |                       |                    | 0.4  |      |  |
|                                 | Control inputs | V <sub>CC</sub> = 0 or 3.45 V,                               | $V_{CC}$ (5 V) = 0 or 5.25 V,   | V <sub>I</sub> = 5.5 V                |                       |                    | 10   |      |  |
|                                 |                |  |                                 | V <sub>I</sub> = 5.5 V                |                       |                    | 20   |      |  |
|                                 | A port         | $V_{CC}$ (3.3 V) = 3.45 V,                                   | V <sub>CC</sub> (5 V) = 5.25 V  | $V_{I} = V_{CC} (3.3 V)$              |                       |                    | 1    |      |  |
| l <sub>l</sub>                  |                |  |                                 | $V_{I} = 0$                           |                       |                    | -30  | μA   |  |
|                                 | Durant         |  |                                 | $V_{I} = V_{CC} (3.3 V)$              |                       |                    | 5    | ]    |  |
|                                 | B port         | $V_{CC}$ (3.3 V) = 3.45 V,                                   | $V_{CC}$ (5 V) = 5.25 V         | $V_1 = 0$                             |                       |                    | -5   |      |  |
| l <sub>off</sub>                |                | V <sub>CC</sub> = 0,   | $V_{I}$ or $V_{O} = 0$ to 4.5 V |                                       |                       |                    | 100  | μΑ   |  |
|                                 | A port         | V <sub>CC</sub> (3.3 V) = 3.15 V,                            |                                 | V <sub>I</sub> = 0.8 V                | 75                    |                    |      |      |  |
| I <sub>I(hold)</sub>            |                |  | V <sub>CC</sub> (5 V) = 4.75 V  | V <sub>1</sub> = 2 V                  | -75                   |                    |      | μΑ   |  |
| ( )                             |                |  |                                 | $V_{I} = 0$ to $V_{CC} (3.3 V)^{(2)}$ |                       |                    | ±500 |      |  |
|                                 | A port         | V <sub>CC</sub> (3.3 V) = 3.45 V,                            | V <sub>CC</sub> (5 V) = 5.25 V, | V <sub>O</sub> = 3 V                  |                       |                    | 1    |      |  |
| I <sub>OZH</sub>                | B port         | V <sub>CC</sub> (3.3 V) = 3.45 V,                            | V <sub>CC</sub> (5 V) = 5.25 V, | V <sub>O</sub> = 1.2 V                |                       |                    | 10   | μA   |  |
|                                 | A port         | V <sub>CC</sub> (3.3 V) = 3.45 V,                            | V <sub>CC</sub> (5 V) = 5.25 V, | V <sub>O</sub> = 0.5 V                |                       |                    | -1   |      |  |
| OZL                             | B port         | V <sub>CC</sub> (3.3 V) = 3.45 V,                            | V <sub>CC</sub> (5 V) = 5.25 V, | V <sub>O</sub> = 0.4 V                |                       |                    | -10  | μA   |  |
|                                 |                | V <sub>CC</sub> (3.3 V) = 3.45 V,                            |                                 | Outputs high                          |                       |                    | 1    |      |  |
| l <sub>CC</sub><br>(3.3 V)      | A or B port    | $V_{CC}$ (5 V) = 5.25 V, $I_{O}$ =                           |                                 | Outputs low                           |                       |                    | 5    | mA   |  |
| (0.0 V)                         |                | $V_{I} = V_{CC} (3.3 \text{ V}) \text{ or GNI}$              | 0                               | Outputs disabled                      |                       |                    | 1    |      |  |
|                                 |                | $V_{CC}$ (3.3 V) = 3.45 V,                                   |                                 | Outputs high                          |                       |                    | 120  |      |  |
| I <sub>CC</sub><br>(5 V)        | A or B port    | $V_{CC} (5.3 \text{ V}) = 5.25 \text{ V}, I_0 =$             | = 0,                            | Outputs low                           | 120                   |                    | mA   |      |  |
| (3 V)                           |                | $V_{I} = V_{CC} (3.3 \text{ V}) \text{ or GNE}$              | )                               | Outputs disabled                      |                       |                    | 120  |      |  |
| ∆I <sub>CC</sub> <sup>(3)</sup> |                | $V_{CC}$ (3.3 V) = 3.45 V, V<br>A-port or control inputs     | e input at 2.7 V                |                                       |                       | 1                  | mA   |      |  |
| C <sub>i</sub>                  | Control inputs | V <sub>I</sub> = 3.15 V or 0                                 |                                 |                                       |                       | 3.5                |      | pF   |  |
| ~                               | A port         | V <sub>O</sub> = 3.15 V or 0                                 |                                 | 12                                    |                       | - 5                |      |      |  |
| C <sub>io</sub>                 | B port         | Per IEEE Std 1194.1  |                                 |                                       | 5                     | pF                 |      |      |  |

(1)

All typical values are at  $V_{CC}$  (3.3 V) = 3.3 V,  $V_{CC}$  (5 V) = 5 V,  $T_A$  = 25°C. This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to (2) another.

This is the increase in supply current for each input that is at the specified TTL voltage level, rather than  $V_{CC}$  or GND. (3)

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#### **Timing Requirements**

over recommended ranges of supply voltage and operating free-air temperature,

 $V_{TT}$  = 1.2 V and  $V_{REF}$  = 0.8 V for GTL (unless otherwise noted) (see Figure 1)

|                    |                 |                            | MIN | MAX | UNIT |
|--------------------|-----------------|----------------------------|-----|-----|------|
| f <sub>clock</sub> | Clock frequency |                            |     | 95  | MHz  |
|                    | Pulse duration  | LEAB or LEBA high          | 3.3 |     |      |
| t <sub>w</sub>     | Pulse duration  | CLKAB or CLKBA high or low | 5.5 |     | ns   |
|                    |                 | A before CLKAB1            | 1.3 |     |      |
|                    |                 | B before CLKBA↑            | 2.5 |     |      |
|                    | O stress these  | A before LEAB↓ 0           |     |     |      |
| t <sub>su</sub>    | Setup time      | B before LEBA↓             | 1.1 |     | ns   |
|                    |                 | CEAB before CLKAB↑         | 2.2 |     |      |
|                    |                 | CEBA before CLKBA↑         | 2.7 |     |      |
|                    |                 | A after CLKAB↑             | 1.6 |     |      |
|                    |                 | B after CLKBA↑             | 0.4 |     |      |
|                    |                 | A after LEAB↓              | 4   |     |      |
| t <sub>h</sub>     | Hold time       | B after LEBA↓              | 3.5 |     | ns   |
|                    |                 | CEAB after CLKAB↑          | 1.1 |     |      |
|                    |                 | CEBA after CLKBA↑          | 0.9 |     |      |

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### **Switching Characteristics**

over recommended ranges of supply voltage and operating free-air temperature,  $V_{TT}$  = 1.2 V and  $V_{REF}$  = 0.8 V for GTL (see Figure 1)

| PARAMETER        | FROM<br>(INPUT)       | TO<br>(OUTPUT)                            | MIN | TYP <sup>(1)</sup> | МАХ  | UNIT |
|------------------|-----------------------|---|-----|--------------------|------|------|
| f <sub>max</sub> |                       |   | 95  |                    |      | MHz  |
| t <sub>PLH</sub> | А                     | В   | 1.7 | 3                  | 4.4  | 20   |
| t <sub>PHL</sub> | A                     | D   | 1.4 | 2.8                | 4.5  | ns   |
| t <sub>PLH</sub> | LEAB                  | В   | 2.3 | 3.8                | 5.4  | 20   |
| t <sub>PHL</sub> | LEAD                  | D   | 2.2 | 3.7                | 5.3  | ns   |
| t <sub>PLH</sub> |                       | D   | 2.4 | 4                  | 5.7  |      |
| t <sub>PHL</sub> | CLKAB                 | В   | 2.1 | 3.7                | 5.4  | ns   |
| t <sub>PLH</sub> |                       |   | 4.7 | 6.1                | 8.1  |      |
| t <sub>PHL</sub> | CLKAB                 | CLKOUT                                    | 5.7 | 7.9                | 11.3 | ns   |
| t <sub>PHL</sub> |                       |   | 2.1 | 3.6                | 5.1  | 20   |
| t <sub>PLH</sub> | OEAB                  | B or CLKOUT                               | 2.1 | 3.8                | 5.6  | ns   |
| t <sub>r</sub>   | Transition time, B or |   | 1.2 |                    | ns   |      |
| t <sub>f</sub>   | Transition time, B or | Transition time, B outputs (1 V to 0.5 V) |     |                    |      |      |
| t <sub>PLH</sub> | 5                     | •   | 1.7 | 4                  | 6.7  | ns   |
| t <sub>PHL</sub> | В                     | А   | 1.4 | 2.9                | 4.7  |      |
| t <sub>PLH</sub> |                       |   | 2.4 | 3.8                | 5.8  |      |
| t <sub>PHL</sub> | LEBA                  | А   | 2   | 3                  | 4.6  | ns   |
| t <sub>PLH</sub> |                       |   | 2.6 | 4                  | 6    |      |
| t <sub>PHL</sub> | CLKBA                 | А   | 2.2 | 3.4                | 4.9  | ns   |
| t <sub>PLH</sub> |                       | OL KIN                                    | 7.4 | 10                 | 14.4 |      |
| t <sub>PHL</sub> | CLKOUT                | CLKIN                                     | 6.1 | 8.1                | 11.7 | ns   |
| t <sub>en</sub>  |                       |   | 2.8 | 5.3                | 7.8  | ns   |
| t <sub>dis</sub> | OEBA                  | A or CLKIN                                | 2.7 | 4.3                | 6.4  |      |

(1) All typical values are at V<sub>CC</sub> (3.3 V) = 3.3 V, V<sub>CC</sub> (5 V) = 5 V, T<sub>A</sub> = 25°C.

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#### **Timing Requirements**

over recommended ranges of supply voltage and operating free-air temperature,

 $V_{TT}$  = 1.5 V and  $V_{REF}$  = 1 V for GTL+ (unless otherwise noted) (see Figure 1)

|                    |                 |                             | MIN | MAX | UNIT |
|--------------------|-----------------|-----------------------------|-----|-----|------|
| f <sub>clock</sub> | Clock frequency |                             |     | 95  | MHz  |
|                    | Pulse duration  | LEAB or LEBA high           | 3.3 |     |      |
| t <sub>w</sub>     | Pulse duration  | CLKAB or CLKBA high or low  | 5.5 |     | ns   |
|                    |                 | A before CLKAB <sup>↑</sup> | 1.3 |     |      |
|                    |                 | B before CLKBA↑             | 2.3 |     |      |
| t <sub>su</sub>    | Catura tima     | A before LEAB↓              | 0   |     | ns   |
|                    | Setup time      | B before LEBA↓              | 1.3 |     |      |
|                    |                 | CEAB before CLKAB↑          | 2.2 |     |      |
|                    |                 | CEBA before CLKBA↑          | 2.7 |     |      |
|                    |                 | A after CLKAB↑              | 1.6 |     |      |
|                    |                 | B after CLKBA↑              | 0.6 |     |      |
|                    |                 | A after LEAB↓               | 4   |     |      |
| t <sub>h</sub>     | Hold time       | B after LEBA↓               | 3.5 |     | ns   |
|                    |                 | CEAB after CLKAB↑           | 1.1 |     |      |
|                    |                 | CEBA after CLKBA↑           | 0.9 |     |      |

TEXAS INSTRUMENTS

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### **Switching Characteristics**

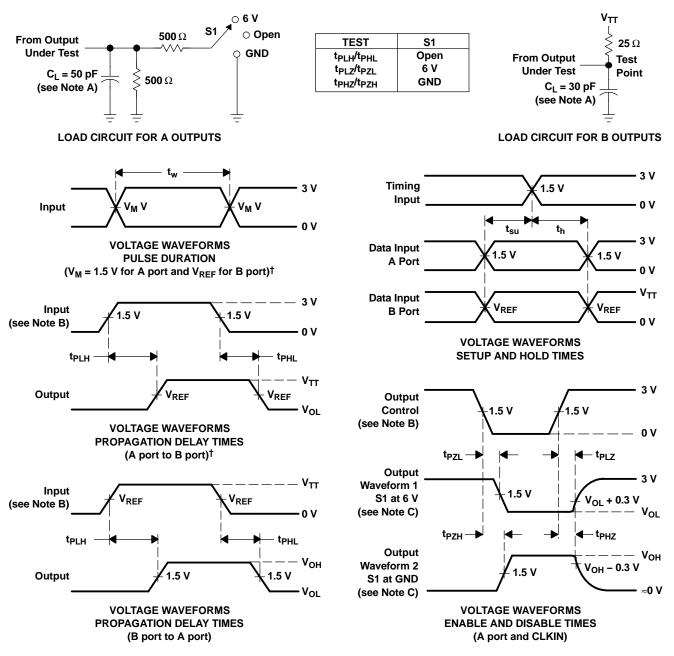
over recommended ranges of supply voltage and operating free-air temperature,  $V_{TT}$  = 1.5 V and  $V_{REF}$  = 1 V for GTL+ (see Figure 1)

| PARAMETER        | FROM<br>(INPUT)      | TO<br>(OUTPUT) | MIN | TYP <sup>(1)</sup> | МАХ  | UNIT |
|------------------|----------------------|----------------|-----|--------------------|------|------|
| f <sub>max</sub> |                      |                | 95  |                    |      | MHz  |
| t <sub>PLH</sub> | ٨                    | В              | 1.7 | 3                  | 4.4  |      |
| t <sub>PHL</sub> | A                    | D              | 1.4 | 2.9                | 4.6  | ns   |
| t <sub>PLH</sub> | LEAB                 | В              | 2.3 | 3.8                | 5.4  | ~~~  |
| t <sub>PHL</sub> | LEAD                 | D              | 2.2 | 3.7                | 5.4  | ns   |
| t <sub>PLH</sub> | CLKAB                | В              | 2.4 | 4                  | 5.7  | 20   |
| t <sub>PHL</sub> | CERAB                | D              | 2.1 | 3.8                | 5.5  | ns   |
| t <sub>PLH</sub> | CLKAB                | CL KOUT        | 4.7 | 6.1                | 8.1  | ns   |
| t <sub>PHL</sub> | CERAB                | CLKOUT         | 5.7 | 8                  | 11.4 |      |
| t <sub>PLH</sub> | OEAB                 | B or CLKOUT    | 2.1 | 3.6                | 5.1  | ns   |
| t <sub>PHL</sub> | OEAB                 | B OI CLKOUT    | 2.1 | 3.8                | 5.7  | ns   |
| t <sub>r</sub>   | Transition time, B o |                | 1.4 |                    | ns   |      |
| t <sub>f</sub>   | Transition time, B o |                | 1   |                    | ns   |      |
| t <sub>PLH</sub> | P                    | ٨              | 1.6 | 3.9                | 6.6  | ns   |
| t <sub>PHL</sub> | В                    | A              | 1.3 | 2.8                | 4.5  |      |
| t <sub>PLH</sub> | LEBA                 | ٨              | 2.4 | 3.8                | 5.8  |      |
| t <sub>PHL</sub> | LEBA                 | A              | 2   | 3                  | 4.6  | ns   |
| t <sub>PLH</sub> | CLKBA                | ٨              | 2.6 | 4                  | 6    | 20   |
| t <sub>PHL</sub> | CERBA                | A              | 2.2 | 3.4                | 4.9  | ns   |
| t <sub>PLH</sub> | CLKOUT               | CLKIN          | 7.3 | 9.9                | 14.3 | 20   |
| t <sub>PHL</sub> | ULNUUI               | ULNIN          | 6   | 8                  | 11.5 | ns   |
| t <sub>en</sub>  | OEBA                 | A or CLKIN     | 2.8 | 5.3                | 7.8  | ns   |
| t <sub>dis</sub> | UEDA                 |                | 2.7 | 4.3                | 6.4  |      |

(1) All typical values are at V<sub>CC</sub> (3.3 V) = 3.3 V, V<sub>CC</sub> (5 V) = 5 V, T<sub>A</sub> = 25°C.

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#### PARAMETER MEASUREMENT INFORMATION $V_{TT} = 1.2 V$ , $V_{REF} = 0.8 V$ FOR GTL AND $V_{TT} = 1.5 V$ , $V_{REF} = 1 V$ FOR GTL+



<sup>†</sup> All control inputs are TTL levels.

- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>r</sub>  $\leq$  2.5 ns, t<sub>f</sub>  $\leq$  2.5 ns. C. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control.
  - Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - D. The outputs are measured one at a time, with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



#### **PACKAGING INFORMATION**

| Orderable part number | Status<br>(1) | Material type (2) | Package   Pins | Package qty   Carrier | <b>RoHS</b><br>(3) | Lead finish/<br>Ball material | MSL rating/<br>Peak reflow | Op temp (°C) | Part marking (6) |
|-----------------------|---------------|-------------------|----------------|-----------------------|--------------------|-------------------------------|----------------------------|--------------|------------------|
|                       |               |                   |                |                       |                    | (4)                           | (5)                        |              |                  |
| SN74GTL16616DLR       | Active        | Production        | SSOP (DL)   56 | 1000   LARGE T&R      | Yes                | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | GTL16616         |
| SN74GTL16616DLR.B     | Active        | Production        | SSOP (DL)   56 | 1000   LARGE T&R      | Yes                | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | GTL16616         |

<sup>(1)</sup> **Status:** For more details on status, see our product life cycle.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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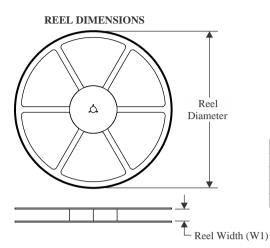
Pin1 Quadrant

Q1



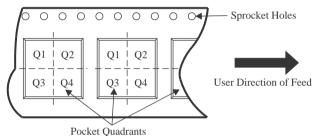
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### **TAPE AND REEL INFORMATION**





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal |      |                    |    |      |                          |                          |            |            |            |            |           |  |
|-----------------------------|------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|--|
| Device                      |      | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) |  |
| SN74GTL16616DLR             | SSOP | DL                 | 56 | 1000 | 330.0                    | 32.4                     | 11.35      | 18.67      | 3.1        | 16.0       | 32.0      |  |



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# PACKAGE MATERIALS INFORMATION

24-Jul-2025

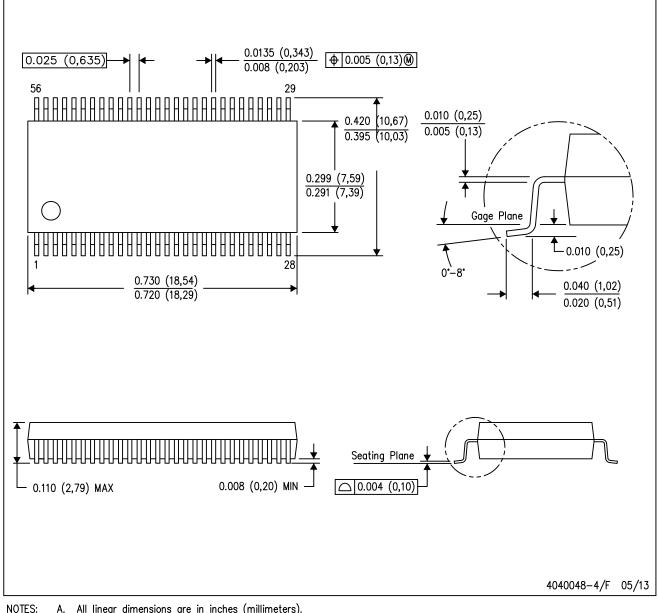


\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74GTL16616DLR | SSOP         | DL              | 56   | 1000 | 356.0       | 356.0      | 53.0        |

DL (R-PDSO-G56)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice. В.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15). C.
  - D. Falls within JEDEC MO-118

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